### Record of Letter Ballot Review by TC Chapter for Procedural Review

Region/Locale: Japan

**Global Technical Committee: Silicon Wafer** 

TC Chapter Cochairs: Tetsuya Nakai (SUMCO), Naoyuki Kawai (Meiji University), Ryuji Takeda (GWJ)

Standards Staff: Mami Nakajo

	Scheduled in Background Statement	Actual
Date	7/21/2020	01/15/2021
Location	San Francisco, CA	Tokyo, Japan
Reason for Change of Date and/or Location (if changed)	COVID-19 pandemic	

Note: See Regulations ¶ 9.5 Exceptions for allowable reason to change.

## I. Document Number and Title

Document Title
Reapproval of SEMI M77-01015, Test Method for
Determining Wafer Near-Edge Geometry Using Roll-
Off Amount, ROA

### **II. Tally**

Standards staff to fill in.

Voting Tally: As-cast tally after close of voting period

Note: A minimum of 60% of the Voting Interests that have TC Members within the global technical committee that issued the Letter Ballot must return Votes. (*Regulations* ¶ 9.6.2.1.1)

### **Voting Tally:**

Voting Interest:	Returned Votes		Distribution		Return Rate	
Letter Ballot	56	÷	92	=	60.9%	≥60%
Intercommittee Ballot	0					
Voting Interest Reject(s)	0		Total Vo	ters	with Rejects	0
Voting Interest Accept(s)	39					

Note: See Regulations § 3.2.1 for definition of Voting Interest.

# III. Rejects

None

### **IV. Other Technical Issues**

### **V. Comments**

V- (i) Voters' Comments
Commenter 1 (Rafael Vargas-Bernal/Instituto Tecnologico Superior de Irapuato) Comment 1 Comm

n <u>me</u>	ent 1												
Comment	*TF	/TC Chapte	er to	fill in section/paragraph #, if necessary.									
nent	In s	subsection 4.1, SEMI M70 must say 'Geometry' not 'Geomtry'											
	The	The TC Chapter agreed to do one of the following actions.											
	*No	motion is	requ	uired in this step.									
Δ		Already addressed by Commenter #, Comment #											
Action		No further action was taken by the TC Chapter.											
7		Refer to th	ne TF	for more consideration.									
		New Busin	ness										
	Х	Editorial C	hang	је									
		Options		Case 1: No vote in this section:									
		for		To be included and voted on as a group in § VI. Editorial Changes Other than Those Voted on in § V.									
		editorial change		Case 2: Voted in this section:									
		(check one)	х	Original section number and at least one full sentence are required "FROM" and "TO" fields.									
		4.1 Refe	renc	on/Paragraph xxx eed Standards and Documents Test Method for Determining Wafer Near-Edge Geomtry Using partial Wafer									
Edito	1	TO: Section/Paragraph xxx SEMI M70 — Test Method for Determining Wafer Near-Edge Geometry Using partial Wafer Site Flatness											
Editorial Changes		Justification (If necessary) Type1 Editorial Change											
anges		FROM: S	ectio	on/Paragraph xxx									
	2	TO: Sect	ion/F	Paragraph xxx									
		Justifica	tion(	(If necessary)									

Motion	To approve above editorial change(s)				
Motion by/2 <sup>nd</sup> by Masanori Yoshise (Wafer Information Service)/ Tetsuya Nakai (SUMCO)					
Discussion	None				
Vote	7 Y-0 N; Motion passed				

### V-(ii) Comments Created by Handling Negative

#### None

### VI. Editorial Changes Other than Those Voted on in § V

Original section/paragraph number and at least one full sentence are required in "FROM" and "TO" fields.

None other than above

### **VII. Approval Conditions Check**

### VII. - (i). Approval Rate

APPROVAL CONDITION 1: All Negatives have been discussed and were withdrawn, found not related, found not persuasive, or addressed by a technical change. (*Regulations* ¶ 9.6.2.1.2)

APPROVAL CONDITION 2: At least 90% of the sum of valid Voting Interest Accept and Voting Interest Reject Votes must be Accept. (*Regulations* ¶ 9.6.2.1.3)

Note: If both approval conditions are not satisfied, the Document fails.

			(Accepts + Valid			
Approval Rate		Accepts 39	Valid Rejects)	 	100.0%	≥90%
Approval Rate	_	37	37		100.0 70	25070

### VII. – (ii) Approval Level (check one)

Note: See *Regulations* § 9.6.2 for further information.



Globally Approved (No Ratification Ballot needed):
The Letter Ballot meets the Letter Ballot approval conditions for the global technical committee.



The Letter Ballot meets the Letter Ballot approval conditions for the TC Chapter and a Ratification Ballot will be issued to validate technical changes.

### **VIII. Safety Check**

Note: See Regulations § 15 for further information.

	X	Th is:	nis is not a Safety Document, when all safety-related information is removed, the Document still technically sound and complete. ( <i>Regulations</i> ¶ 8.7.1)							
Motion			This is a Safety Document, when all safety-related information is removed, the Document is not technically sound and complete. (Regulations ¶ 8.7.2)							
				Safety Checklist ( <i>Regulations</i> ¶ 15.3) is complete and has been included with the Document hroughout the balloting process. ( <i>Regulations</i> ¶ 15.1.2)						
	Motion by/2 <sup>nd</sup> by			Masanori Yoshise (Wafer Information Service)/ Tetsuya Nakai (SUMCO)						
	D	iscı	None							
		7 Y-0 N; Motion passed								

### IX. Intellectual Property (IP) Check

Note: This Letter Ballot may cover all or part of a Standard or Safety Guideline. Regardless of the coverage, this IP check applies to the entire Standard or Safety Guideline\*. See *Regulations* § 16 for further information.

X	The TC Chapter meeting chair asked those participating, if they were aware of any patented technology that might be relevant (see <i>Regulations</i> ¶ 16.3.1.1) to the Standard or Safety Guideline; or, any copyrighted items or trademarks that are used/reproduced (see <i>Regulations</i> ¶ 16.4.1.2) in the Standard or Safety Guideline. (Also see, <i>Regulations</i> § 8.8)								
		The question is NOT answered in affirmative (No potentially material patented technology or use/reproduction of copyrighted items/trademarks is known.)	GO TO SECTION X.						
	X  The question is answered in affirmative		Is any of the known IPs a patented		Yes, at least one of them is a patented technology	GO TO IX (a) "Patented Technology" subsection			
			technology?		No	GO TO IX (b) "Copyright items" subsection			

IX(a) Patented Technologies subsection IX(a1) Total numbers of Patented Technologies to be dealt with

1 Fill	(I) Known Patented Technology that might be relevant to the Standard/Safety Guideline	Fill	technologies first became known to the TC Chapter on or after the day	Postpone assessment of such patented technologies to be performed at the next scheduled TC Chapter meeting.
		Fill	(n) Number of patented technologies first became known to the TC Chapter before the day of the issuance of this Letter Ballot	GO TO IX (a2)

IX(a2) Assessment of disclosed patented technologies

Disclosed patented techno (Brief description, e.g., pate	Date of Asse Letter Ballot MM/DD/YYY	adju		erent from the date of				
Is disclosed patented			Is the us	se of this	X	YES PROCEED to assess NEXT one, or if this is the last on GO TO IX(a3)		
technology #1 found to be "might be material" to the Standard/Safety Guideline?			justified	•		NO	The Document is failed and returned to the TF	
	NO			No further action is needed for patented technology #1			d technology #1	

This table is needed for each disclosed patented technology.

IX(a3) LOA status check of PMPT of which inclusion assessed to be justified

LOA Status of PMPT #1									
	Х	YES		PROCEED to check NEXT one, or if this is the last one, GO TO IX(b)					
Has an LOA for this patented technology		NO	MC		Ask ISC for spe	Ask ISC for special permission to publish.			
been received from every owner?			MOTION		Quit activity.	The Document is failed and returned to the TF			
					Wait for LOA	PROCEED to check NEXT one, or if this is the last one, GO TO IX(b1)			
			Motion by/ 2 <sup>nd</sup> by			Name (Company)/Name (Company)			
				cuss	sion	XXXX			
		Vot	е		XX Y-XX N; Motion passed (or failed)				

This table is needed for each PMPT of which inclusion assessed to be justified.

IX(b1) Total numbers of copyrighted items to be dealt with

Standard/Safety Guideline	X	o = 0 There is no disclosed copyrighted item	GO TO IX (c)
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IX(b2) Assessment of disclosed copyrighted items

Disclosed copyrighted item #1 (Brief description of its use in the Document):							
Is disclosed copyrighted		YES	Is the use/reproduction of this copyrighted item technically justified?		YES	PROCEED to assess NEXT one, or if this is the last one, GO TO IX(b3)	
item #1 used or reproduced in the Standard/Safety Guideline?					NO	The Document is failed and returned to the TF	
		NO	No further action is nee	hted item #1			

This table is needed for each disclosed copyrighted item.

# IX(b3) Copyright release status check of copyrighted item of which inclusion assessed to be justified

dstilled								
Copyright release Status of copyrighted item #1								
		YES			ne, or IX(c)			
Has the copyright release been received from its owner ?.		NO	MOTION		Ask ISC for special permission to publish.			
					Quit activity.	The Document is failed and returned to the TF		
					Wait for copyright release letter	PROCEED to check NEXT one, or if this is the last one, GO TO IX(c)		
			Мо	tion	by/ 2 <sup>nd</sup> by	Name (Company)/Name (Company)		
			Dis	cuss	sion	XXXX		
			Vot	е		XX Y-XX N; Motion passed (or failed)		

This table is needed for each copyrighted item of which use/reproduction assessed to be justified.

IX(c) Assessment of disclosed (identified) trademark

Is there any trademark in the Standard/Safety Guideline?		YES	Is every instance of trademark use technically justified?	YES	GO TO IX(d)
				NO	The Document is failed and returned to the TF
		NO	GO TO IX(d)	-	

IX(d) IP check completion condition check

The co-chair checks if any Patented Technologies first become known to		YES	Sections IX(a2) and IX(a3) shall be completed and recorded for such patented technologies at next scheduled meeting of the TC Chapter. Until then, the
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the TC Chapter on or after the day of the issuance of this Letter Ballot? i.e., m>0 in IX(a1)			TC Chapter shall NOT go to X (making motion to pass/fail this Document) (see Regulations ¶ 16.4.1.2) Until then this Letter Ballot Review is on hold.
	X	NO	<b>GO TO X</b>

### X. Action for This Document

			ment passed TC Chapter review as balloted and will be forwarded to the ISC A&R cedural review.							
M	x		nent passed TC Chapter review with editorial changes and will be forwarded to the C for procedural review.							
Motion		editorial ch	nent passed TC Chapter review with technical changes and with or without anges and will be forwarded to the ISC A&R SC for procedural review. A Ballot will be issued to verify the technical changes.							
		This Document failed TC Chapter review and will be returned to the TF for rework.								
		This Docur	ment failed TC Chapter review and work will be discontinued.							
•	Motion by/ 2 <sup>nd</sup> by		Masanori Yoshise (Wafer Information Service)/ Tetsuya Nakai (SUMCO)							
Discussion			None							
	٧	ote	7 Y-0 N							
F	Final Action		X Motion passed							
			Motion failed							

Note: If the use of PMPT or copyrighted item is justified by the TC Chapter, LOA or release form must be received before publication can proceed.